



ELEN E3106/4106 Lecture 12

Optoelectronics Part I: Solar Cells & Photodiodes Outline

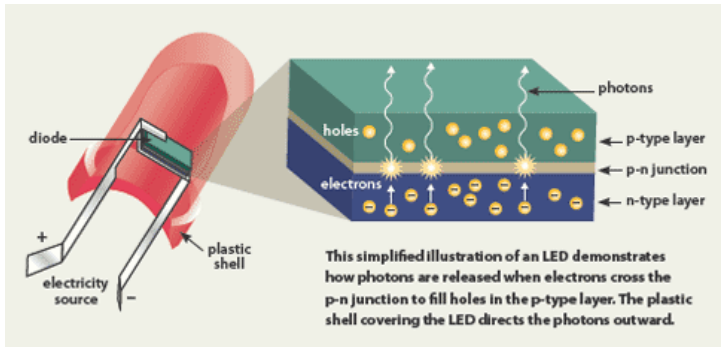
- I - V in illuminated junctions
- Solar Cells
- Photodetectors
- Gain, Bandwidth, and SNR

Assignments:

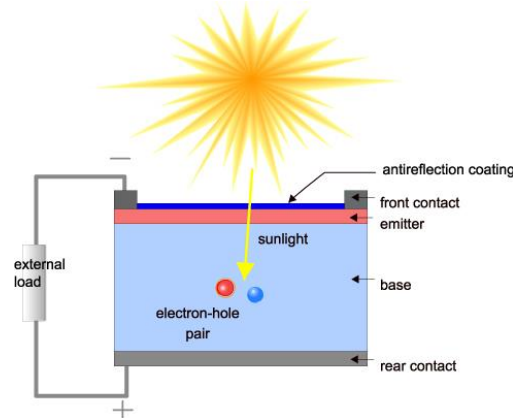
Reading: Streetman and Banerjee §8.1
Homework 5 due Friday Oct. 17th by 5pm

p-n Diode: Applications in Optoelectronics

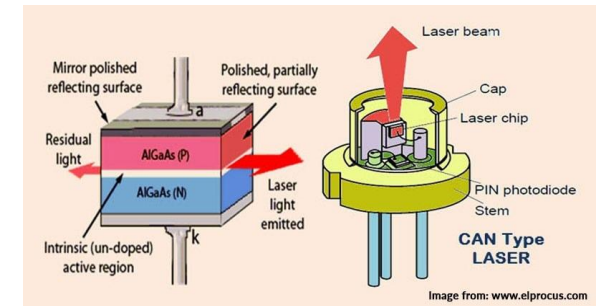
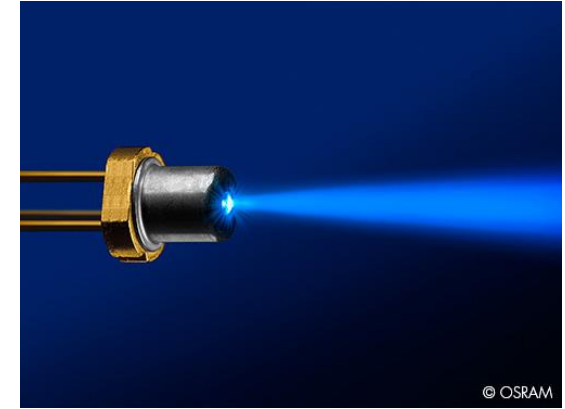
LEDs



Solar cells



Laser Diodes



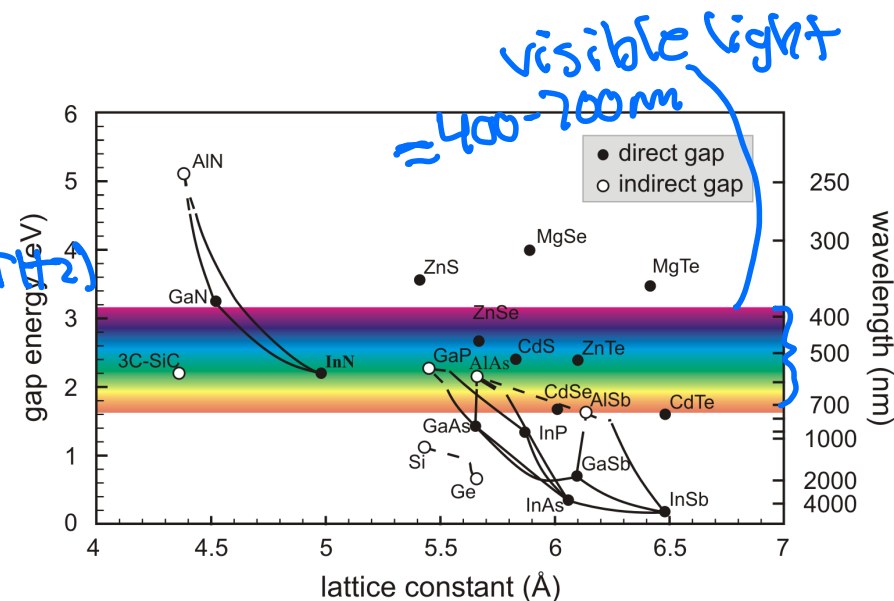
Optoelectronic Materials

- Recall, conventional Si has a lot going for it
 - Easily purified and grown as a single crystal
 - Cheap
 - Abundant in nature
 - Easily passivated by SiO_2 (a great insulator w/ high etch selectivity to Si)
- Overall, good solution for complex & cheap digital & analog circuits
- But** we also need high speed (10 GHz - 1 THz) optical components like receivers and emitters
- Many other semis have superior properties
 - Higher mobility \rightarrow higher frequencies
 - Better light emission/absorption

Theoretical

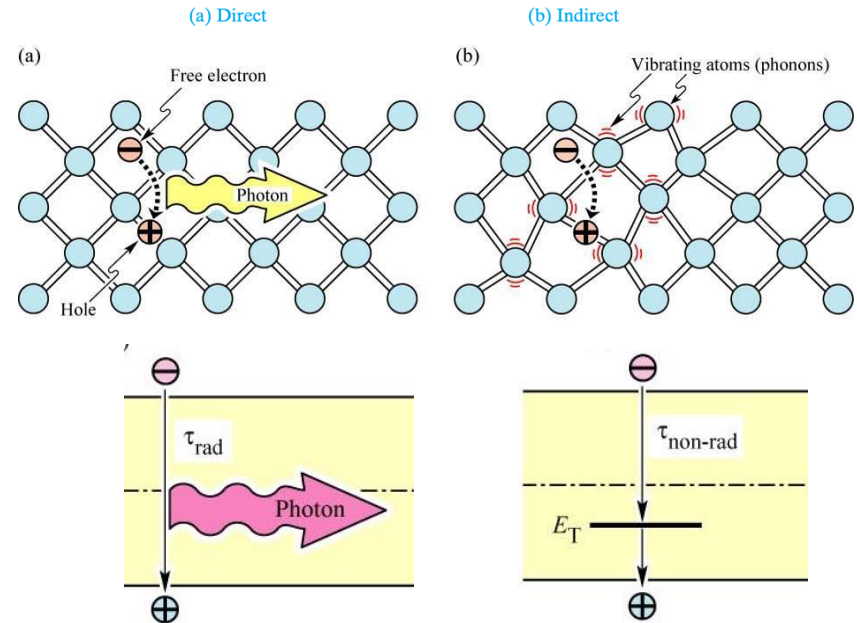
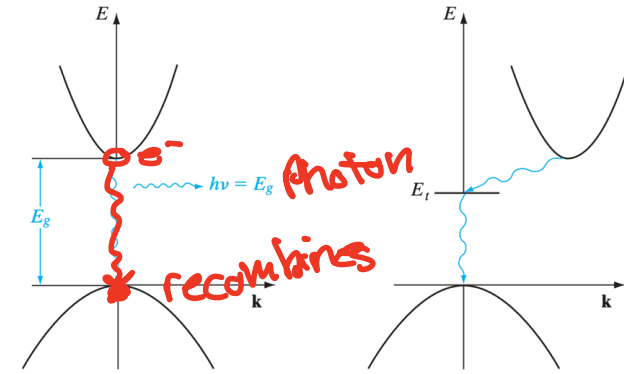
TABLE 2-1 • Electron and hole mobilities at room temperature of selected lightly doped semiconductors.

	Si	Ge	GaAs	InAs
μ_n ($\text{cm}^2/\text{V}\cdot\text{s}$)	1400	3900	8500	30,000
μ_p ($\text{cm}^2/\text{V}\cdot\text{s}$)	470	1900	400	500



Recall: Direct and Indirect Bandgap

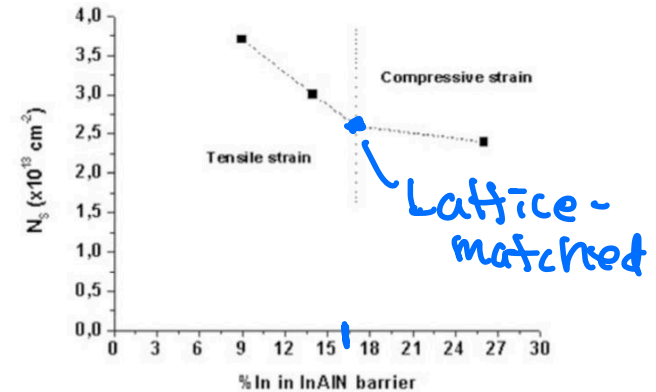
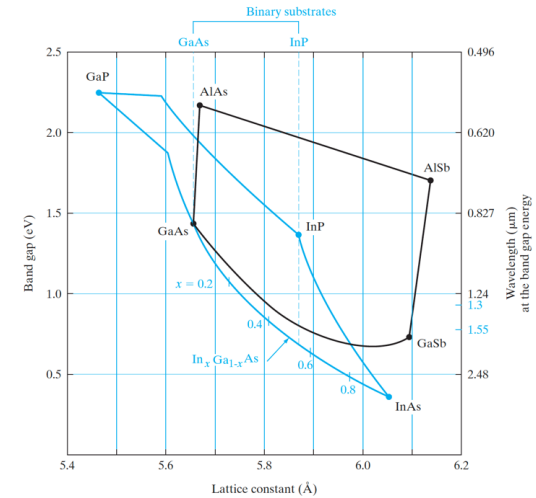
- Direct: recombination results in photon emission (radiative)
- Indirect: $E_{c,min}$ and $E_{v,max}$ do not occur at same k ->
 - Recombination requires a change of momentum for the e^-
 - Non-radiative!
 - Released energy converted to thermal lattice vibrations (phonons)



Direct Band Gaps and Lattice Matching for Optoelectronics

- Generally, we focus on direct bandgaps for optoelectronics
 - GaAs
 - InP
 - GaN
- Recall: we can tailor the lattice constant a through alloy composition (generally it varies linearly)
- Important: Lattice-matching
 - When all the semiconductors in the structure have the same lattice constant
 - Otherwise, the lattice mismatch can produce defects
- Why do we need to grow some semiconductors on substrates of a different material? Called heteroepitaxy

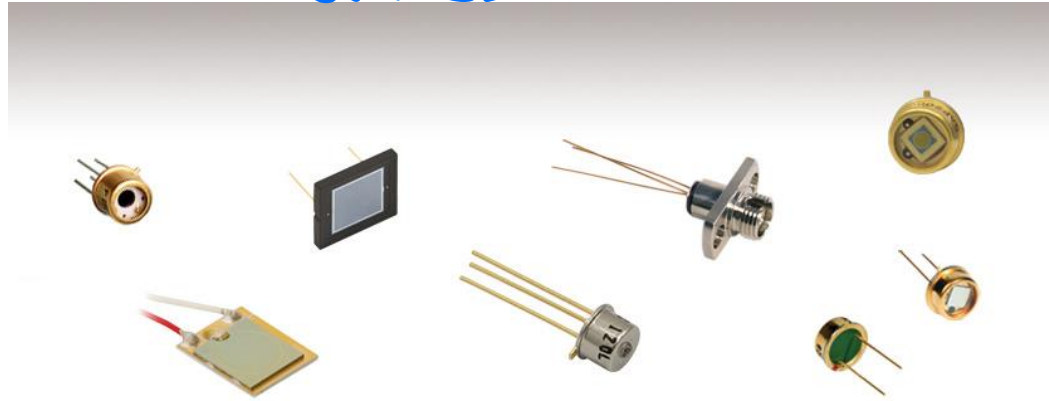
Difficult & expensive to produce some semiconductors in bulk; ability to grow thin layer



17-18% In in InAlN → Lattice matched to underlying GaN → No strain

Photodiode Basics

- 2 terminal devices designed to respond to photon absorption
- Principle of operation based on p-n junction !
- Recall from Ch. 4, semiconductors can absorb light with photon $h\nu \geq \underline{E_g}$
- Why do we use a junction instead of a a slab of semiconductor?
 - Junctions can improve response speed (time) and sensitivity



Current and Voltage in an Illuminated Junction

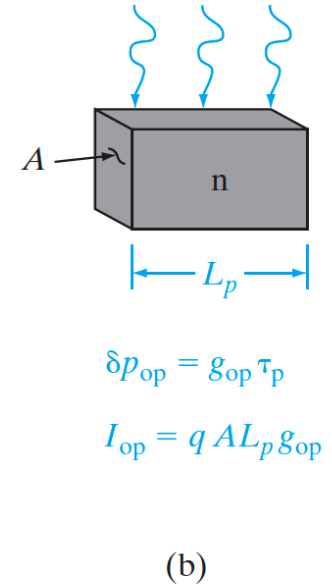
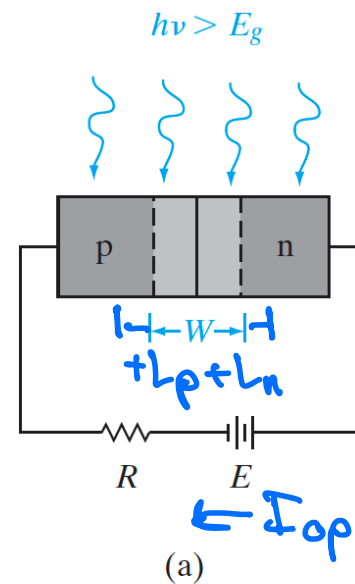
- Assumptions: quantum efficiency (Q.E.) = 1 EHP created for every 1 incoming photon

- If we shine a light with $g_{op} = 10^{17} \frac{\text{EHP}}{\text{cm}^3\text{-s}}$ on a p-n junction, we generate additional current (proportional to light intensity and cell area):

$$I_{op} = q \times g_{op} \times (\text{generation volume})$$

$$I_{op} = q g_{op} A (L_p + L_n + W)$$

- Recall: low-level injection, minority carrier concentration changes a lot!
- Which way is current directed?
 - From n to p



Current and Voltage in an Illuminated Junction

- How does the photogenerated current add (or subtract) to the current already induced by the diode voltage?
 - Recall, ideal diode equation (in the dark):

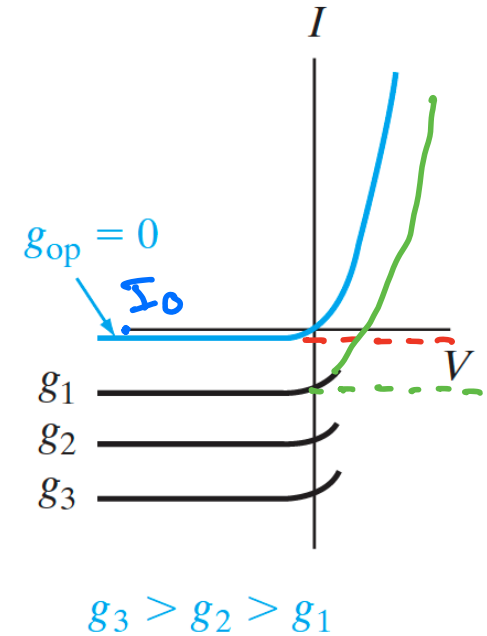
$$I = qA \left(\frac{D_p}{L_p} p_n + \frac{D_n}{L_n} n_p \right) (e^{qV/kT} - 1) = I_0 (e^{qV/kT} - 1)$$

- Let $I_{gen} = I_0 = \underline{I_{th}}$
- Our total current in the illuminated junction is now

$$I = I_{th}(e^{qV/kT} - 1) - I_{op}$$

$$I = qA \left(\frac{L_p}{\tau_p} p_n + \frac{L_n}{\tau_n} n_p \right) (e^{qV/kT} - 1) - qA g_{op} (L_p + L_n + W)$$

- Meaning the I-V curve is shifted downwards proportional to g_{op}



Photovoltaic Effect

- Short-circuit (external $V = 0$), $I_{sc} = -I_{op}$
- Open-circuit voltage (external $I = 0$),

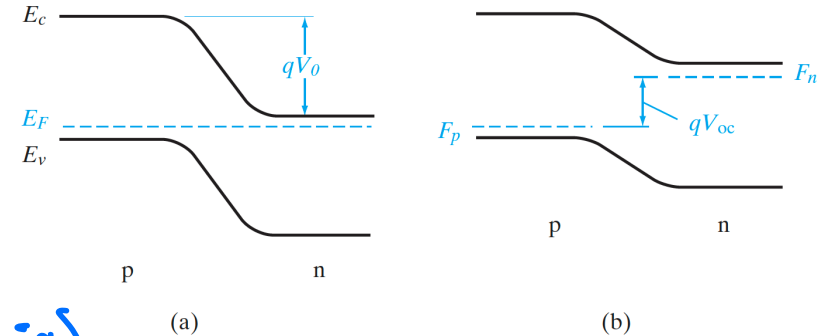
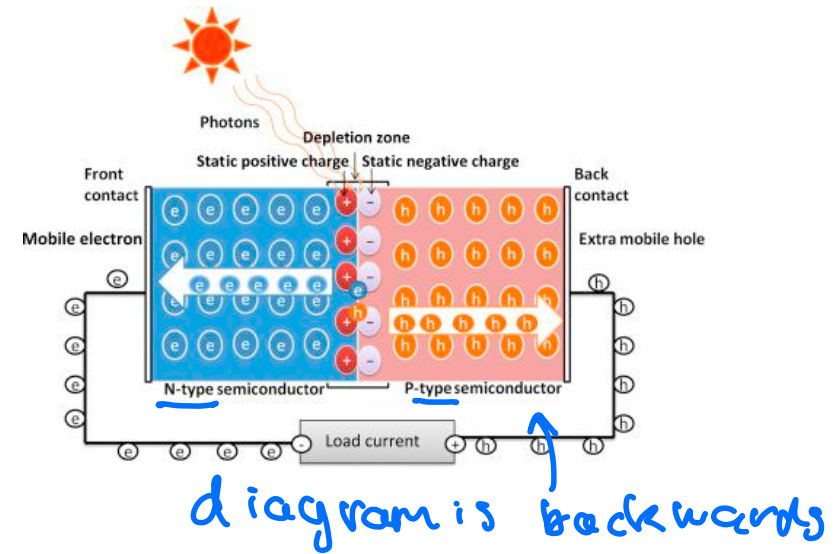
$$V_{oc} = \frac{kT}{q} \ln[I_{op}/I_{th} + 1]$$

$$= \frac{kT}{q} \ln \left[\frac{L_p + L_n + W}{(L_p/\tau_p)p_n + (L_n/\tau_n)n_p} g_{op} + 1 \right]$$

- This appearance of a forward open-circuit voltage across an illuminated junction is called the *photovoltaic effect*

- Note there is a limit: $V_{oc} \leq V_0$

contact potential / built-in potential



Power Delivery

- $|P| = |I \times V|$
- +P: power delivered to the device
- -P: power is generated by the device

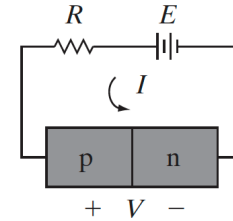
Operating in which quadrant(s) requires power from external circuit?

1st and 3rd

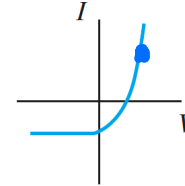
Operating in which quadrant(s) generates power?

4th (product $I \times V$ is negative)

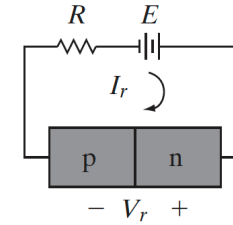
- We choose which quadrant to operate in depending on application.



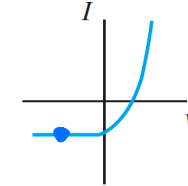
1st quadrant



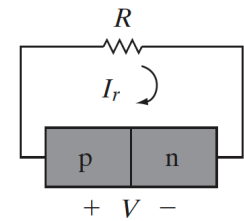
(a)



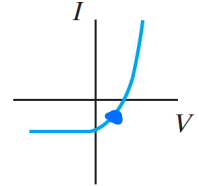
3rd quadrant



(b)



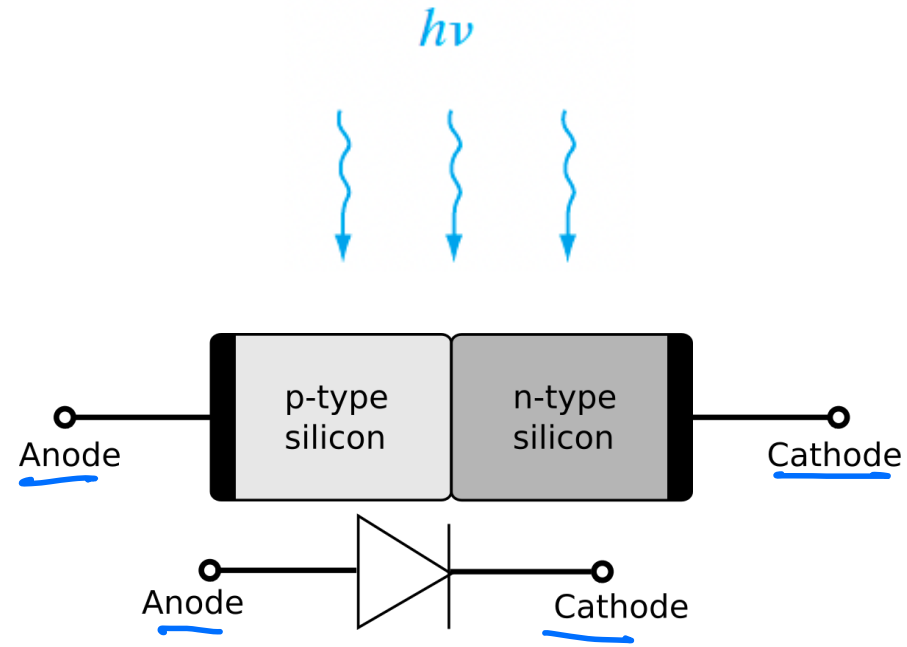
4th quadrant



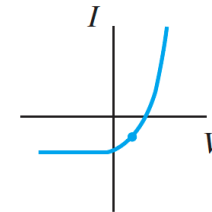
(c)

Solar Cell Basics

- A type of photodiode
- Also called photovoltaic cells
- Convert optical power (sunlight) into electricity
 - 4th quadrant
- Energy efficiencies usually 15-30%
- Structure: identical to p-n diode, with transparent anti-reflective coating on top
- How much power can a single 1 cm^2 device deliver? Not a lot! why solar cells are arrayed
 - $V_{oc} < \underline{0.5 - 1\text{ V}}$
 - $I_{op} \approx 10 - 100\text{ mA}$

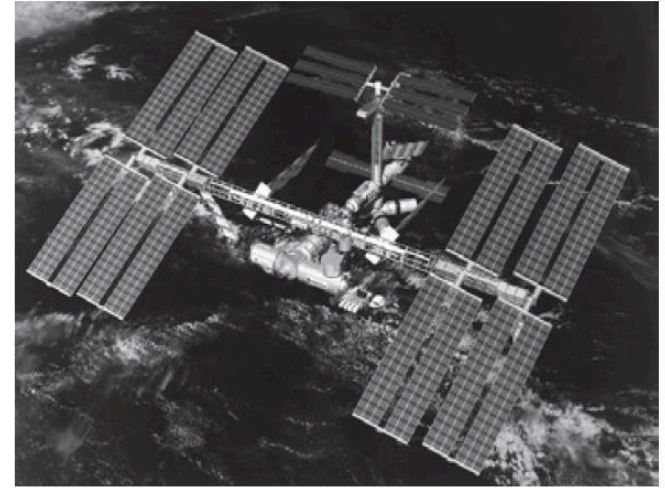


4th quadrant



Solar Cell Design

- How do we generate more power?
Operate an array (panel)
- Connect cells in series to obtain desired voltage, then connect in parallel
series: share a current
parallel: share a voltage
- Desired:
 - Large junction area located
near the surface
 - Small series resistance in the device (maximize output power)
- Compromises: *limit for V_{oc}*
 - Increasing V_0 through doping inadvertently reduces lifetime



(a)

Solar Cell Contact Design

- Contacts are designed as narrow fingers across the surface. Why?
 - Decrease series resistance
 - More exposed surface
- Region is heavily doped, so resistance is small good ohmic contacts! (tunneling)
- BUT if we put contacts only on the edges, current must flow across entire long surface
 - Series resistance would become large
- Fingers reduce distance current travels, without interfering with incoming light!

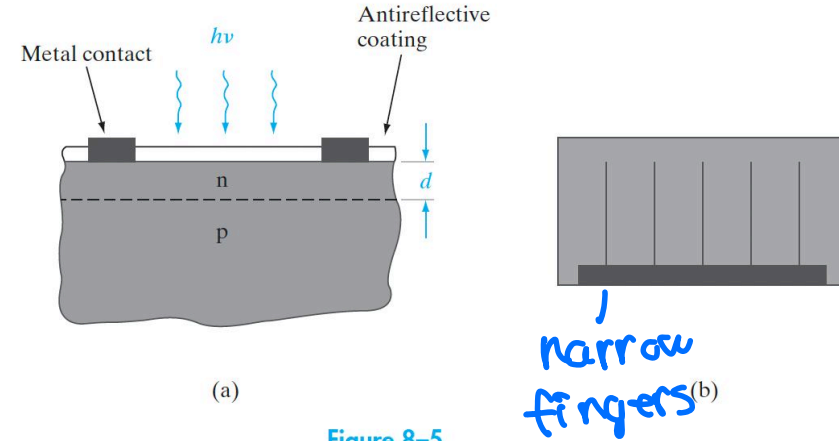


Figure 8-5
Configuration of a solar cell:
(a) enlarged view of the planar junction; (b) top view, showing metal contact "fingers."

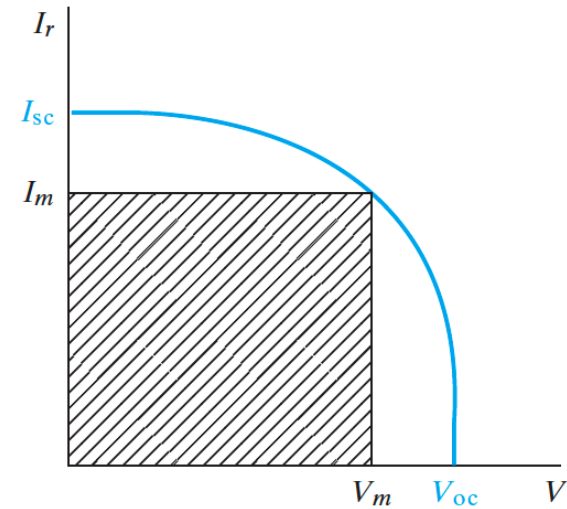
Sometimes transparent electrodes are used!

Solar Cell Fill Factor and Efficiencies

- Fill factor is an important metric of solar cell quality
- The ratio of the actual maximum obtainable power to the product of $I_{sc} V_{oc} = P_{\text{predicted}}$

$$I_m V_m / I_{sc} V_{oc}$$

- We want to maximize f.f.
- Which means we need to manage resistance
- Which means we must optimize:
 - The size and shape of the cell
 - Thickness of device layers
 - Choice of layers
 - Doping



Typically 0.7 (70%)

$$P_{\text{max}} = (f.f.) \underbrace{I_{sc} V_{oc}}_{P_{\text{predicted}}}$$

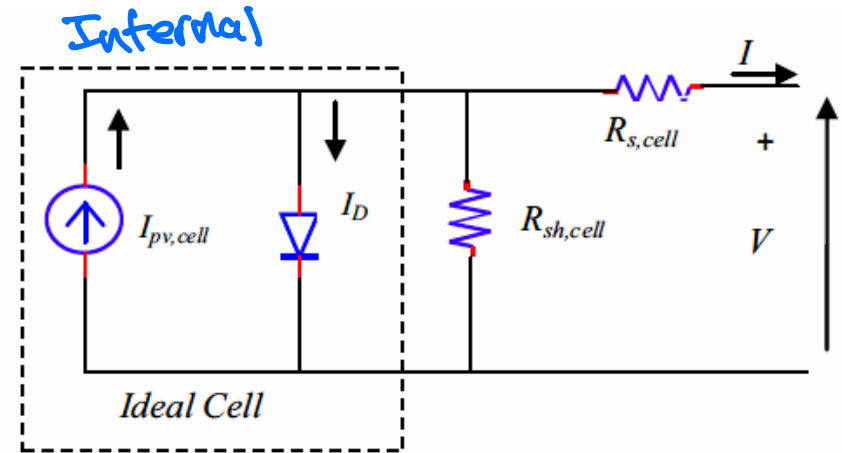
Equivalent Circuit Model of Solar Cells

- I_{pv} : Photocurrent generated due to illumination (photovoltaic effect)
- I_D : Diode characteristics in the dark. Some current passing through the diode doesn't reach the load due to recombination
- R_s : series resistance due to device (p, n layer and metal contacts)
- R_{sh} : shunt resistance due to parallel conductive leakage pathways

• We want to manage resistance to increase power:

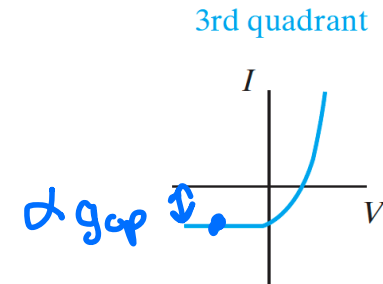
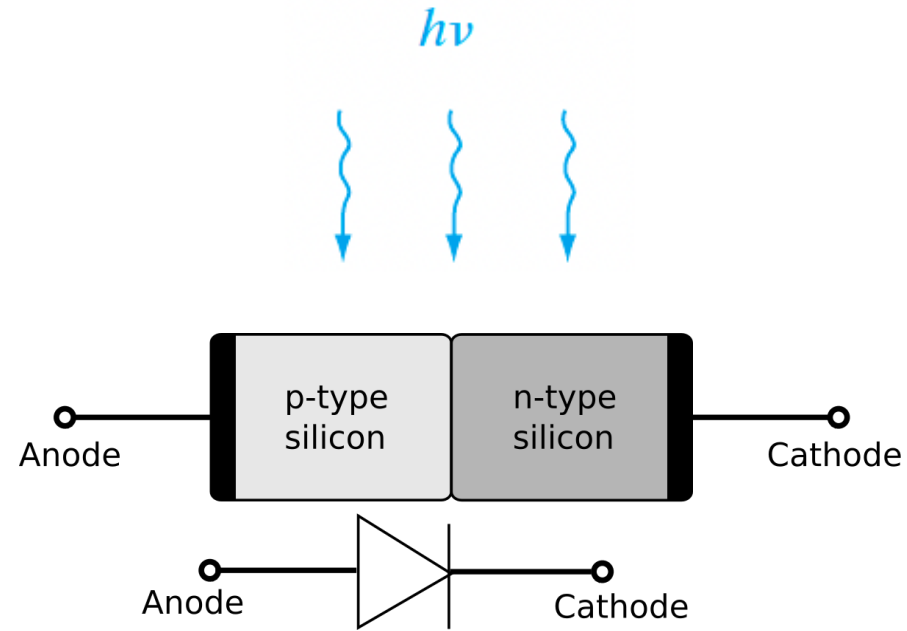
- Decrease series (internal)
- Increase shunt (external)

$$\underline{I} = \underline{I_{pv}} - \underline{I_D} - \underline{I_{R_{sh}}}$$



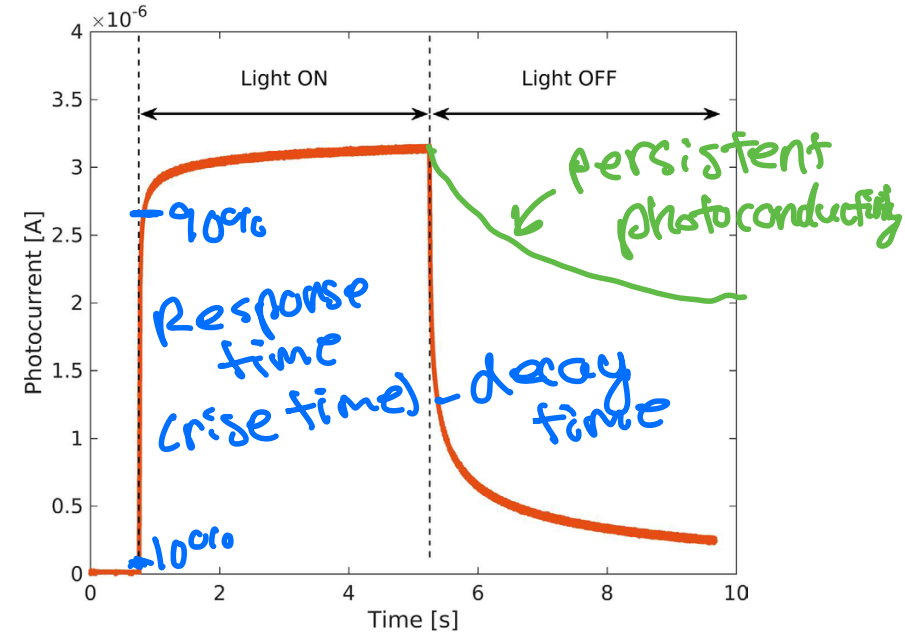
Photodetector Basics

- A type of photodiode
- Converts time-varying optical/light signals into electrical signals
 - 3rd quadrant consume power to operate
- Current is essentially independent of voltage, and proportional to gap
- Imagine we need to detect a series of light pulses 1 ns apart
- The photogenerated minority carriers must diffuse to the junction and be swept across in time $\ll 1\text{ ns}$
- Important metric:
response speed (frequency)



Photodetector Design and Speed

- To improve response time (Bandwidth), increase W so most devices are absorbed in the SCR protons
- EHPs generated in W will be swept to other side very quickly
- Called a depletion-layer photodiode
- How can we increase W?
Dope 1 side heavily (p+n or n+p)
- Compromise:
 - Larger W, most photos absorbed in W and sensitivity is high (pro)
 - Larger W, C_j is small and RC of circuit is low, increasing speed (pro)
 - Larger W, time for carriers to drift across goes up and lowers speed..... (cons)



$$f_{max} \approx \frac{1}{\text{transit time}} \approx \frac{1}{\frac{W}{v_{sat}}} \approx \frac{v_{sat}}{W}$$

$[Hz = s^{-1}]$

Approaches to Improve Photodetector Performance

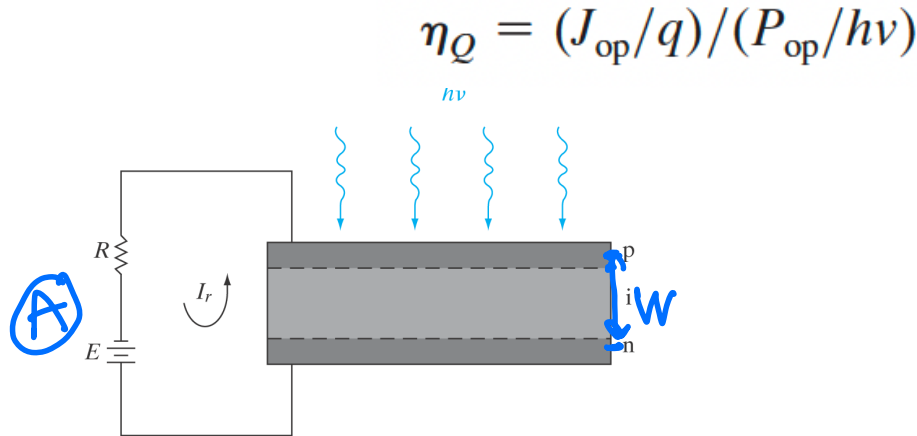
- Use p-i-n as photodetector to enlarge depletion region W , improving response time

(A) (left) \uparrow intrinsic

- Use lattice-matched layers of compound semis with wider bandgap material on top.

(B) Lower energy photons can easily be transmitted through to junction with narrower bandgap material, reducing surface recombination effects (right)

- Operate detector in avalanche region (called an _____). Each photogenerated carrier significantly increases current due to avalanche multiplication (external Q.E. ____ > 100%)



$p+$: InGaAs 9×10^{18} , 30 nm	} $E_g(\text{top}) > E_g(\text{bottom})$
$p+$: InAlAs 9×10^{18} , 100 nm	
$p+$: InAlAs 7×10^{18} , 700 nm	
i : InAlAs spacer, 100 nm	} intrinsic
i : InGaAs, 1500 nm	
i : InAlAs spacer, 100 nm	
p : InAlAs, 6×10^{17} , 150 nm	} n
i : InAlAs, 200 nm	
$n+$: InAlAs, 5×10^{18} , 100 nm	
$n+$: InAlAs, 5×10^{18} , buffer	
$n+$: InP Substrate	

$E_g(\text{top}) > E_g(\text{bottom})$

intrinsic

n

Photodetector Figures of Merit

- Quantum efficiency: # of EHPs generated per photon.
- Responsivity: output current divided by total light power falling upon the photodetector.
- Signal-to-noise ratio (SNR): ratio of desired signal to level of background noise
- Noise-equivalent power (NEP): amount of light power needed to generate a signal comparable in size to the noise of the device (major source: random thermal motion of carriers)
- Detectivity (D): Inversely proportional to the noise equivalent power. $D = 1/NEP$
- Gain: Output current of a photodetector divided by the current directly produced by the photons incident on the detectors, i.e., the built-in current gain.
- Dark current: The current flowing through a photodetector even in the absence of light.
- Response time: The time needed for a photodetector to go from 10% to 90% of final output.

